

TRIACS

Silicon triacs in metal envelopes, intended for industrial a.c. power control, and are particularly suitable for static switching of 3-phase induction motors. They may also be used for furnace control, lighting control and other static switching applications up to an r.m.s. on-state current of 55 A.

Two grades of commutation performance are available, 30 V/ μ s at 25 A/ms (suffix G) and 30 V/ μ s at 50 A/ms (suffix H).

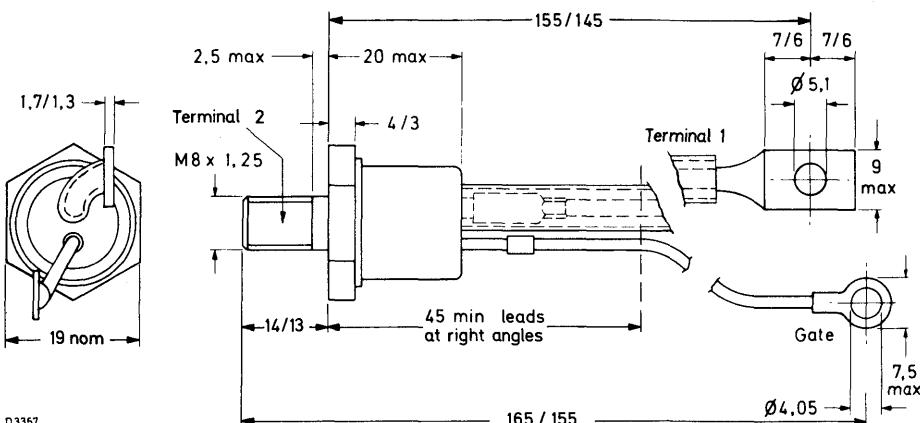
QUICK REFERENCE DATA

	BTW34-600	800	1000	1200	1400	1600	V
Repetitive peak off-state voltage V _{DRM}	max.	600	800	1000	1200	1400	1600
R.M.S. on-state current I _{T(RMS)}							max. 55 A
Non-repetitive peak on-state current I _{TSM}							max. 400 A
Rate of rise of commutating voltage that will not trigger any device (see page 3)				dV _{com} /dt <			30 V/ μ s

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-103.



Net mass: 46 g

Diameter of clearance hole: 8,5 mm

Torque on nut: min. 4 Nm (40 kg cm)
max. 6 Nm (60 kg cm)Supplied with device: 1 nut, 1 lock washer
Nut dimensions across the flats: 13 mm

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages (in either direction)*

		BTW34-600	800	1000	1200	1400	1600	
Non-repetitive peak off-state voltage ($t \leq 10$ ms)	V_{DSM}	max.	700	900	1100	1300	1400	1600 V**
Repetitive peak off-state voltage	V_{DRM}	max.	600	800	1000	1200	1400	1600 V
Crest working off-state voltage	V_{DWM}	max.	400	600	700	800	800	800 V

Currents (in either direction)

R.M.S. on-state current (conduction angle 360°)

up to $T_{mb} = 75$ °Cat $T_{mb} = 85$ °C

$I_T(RMS)$	max.	55 A
$I_T(RMS)$	max.	45 A

Average on-state current for half-cycle operation
(averaged over any 20 ms period) at $T_{mb} = 85$ °C

$I_T(AV)$	max.	21 A
I_{TRM}	max.	300 A

Repetitive peak on-state current

Non-repetitive peak on-state current

 $T_j = 125$ °C prior to surge; $t = 20$ ms; full sine-wave $I^2 t$ for fusing ($t = 10$ ms)

Rate of rise of on-state current after triggering with

 $I_G = 1$ A to $I_T = 100$ A; $dI_G/dt = 1A/\mu s$

I_{TSM}	max.	400 A
$I^2 t$	max.	800 A²s
dI_T/dt	max.	50 A/ μs

*Gate to terminal 1***Power dissipation**

Average power dissipation (averaged over any 20 ms period)

$P_{G(AV)}$	max.	2 W
P_{GM}	max.	10 W

Peak power dissipation

Temperatures

Storage temperature

T_{stg}	—55 to + 125	°C
T_j	max.	125 °C

Junction temperature

THERMAL RESISTANCE

From junction to mounting base

full-cycle operation

$R_{th j-mb}$	=	0,6 °C/W
$R_{th j-mb}$	=	1,2 °C/W

half-cycle operation

From mounting base to heatsink with heatsink compound

$R_{th mb-h}$	=	0,2 °C/W
$Z_{th j-mb}$	=	0,08 °C/W

Transient thermal impedance; $t = 1$ ms* To ensure thermal stability: $R_{th j-a} < 2$ °C/W (full-cycle or half-cycle operation). For smaller heatsinks T_j max should be derated (see Figs 2 and 3).** Although not recommended, higher off-state voltages may be applied without damage, but the triac may switch into the on-state. The rate of rise of on-state current should not exceed 20 A/ μs .

CHARACTERISTICS

Polarities, positive or negative, are identified with respect to T₁.

Voltages (in either direction)

On-state voltage

$$I_T = 65 \text{ A}; T_j = 25^\circ\text{C}$$

$$V_T < 2,1 \text{ V}^*$$

Rate of rise of off-state voltage that will not trigger any device;
exponential method; V_D = 2/3 V_{DRM max}; T_j = 125 °C

$$dV_D/dt < 200 \text{ V}/\mu\text{s}$$

Rate of rise of commutating voltage that will not trigger any device;

$$I_T(\text{RMS}) = 45 \text{ A}; V_D = V_{DRM \text{ max}}; T_{mb} = 85^\circ\text{C}$$

$$dV_{com}/dt (\text{V}/\mu\text{s}) | -dI_T/dt (\text{A}/\text{ms})$$

BTW34-600G to 1600G

$$< 30 | 25$$

BTW34-600H to 1600H

$$< 30 | 50$$

**Currents (in either direction)**

Off-state current

$$V_D = V_{DWM \text{ max}}; T_j = 125^\circ\text{C}$$

$$I_D < 10 \text{ mA}$$

Latching current; T_j = 25 °C

$$T_2 \text{ pos.} | T_2 \text{ neg.}$$

G positive

$$I_L < 250 | - \text{ mA}$$

G negative

$$I_L < 500 | 250 \text{ mA}$$

Holding current; T_j = 25 °C

$$I_H < 200 | 200 \text{ mA}$$

G positive or negative

Gate to terminal 1

Voltage and current that will trigger all devices

$$V_D = 12 \text{ V}; T_j = 25^\circ\text{C}$$

$$\left\{ \begin{array}{l} V_{GT} > 2,5 \\ I_{GT} > 200 \end{array} \right. | - \text{ V}$$

G positive

$$\left\{ \begin{array}{l} -V_{GT} > 2,5 \\ -I_{GT} > 200 \end{array} \right. | - \text{ mA}$$

G negative

$$\left\{ \begin{array}{l} -V_{GT} > 2,5 \\ -I_{GT} > 200 \end{array} \right. | 2,5 \text{ V}$$

$$200 \text{ mA}$$

Voltage that will not trigger any device

$$V_{GD} < 0,2 | 0,2 \text{ V}$$

$$V_D = V_{DRM \text{ max}}; T_j = 125^\circ\text{C}; \text{G positive or negative}$$

* Measured under pulse conditions to avoid excessive dissipation.

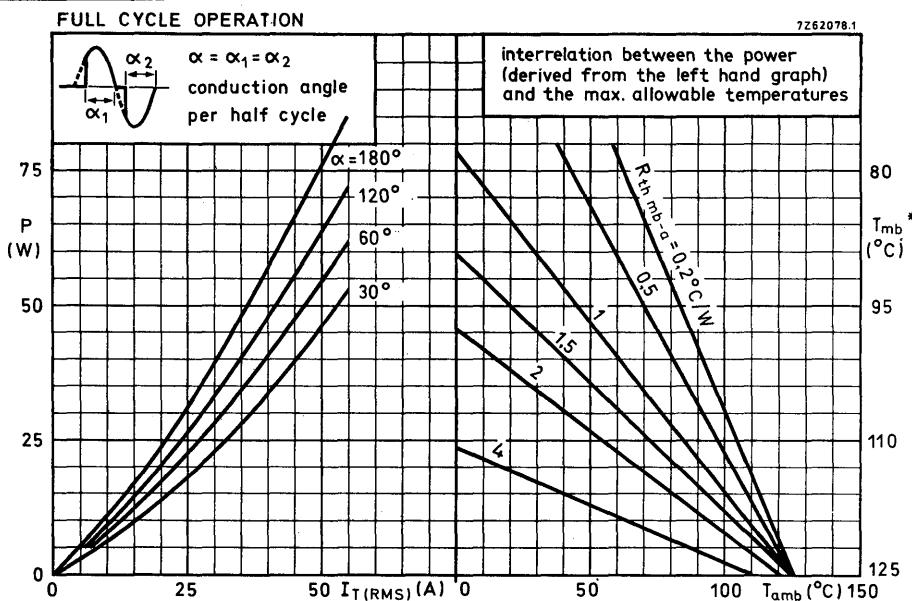


Fig. 2.

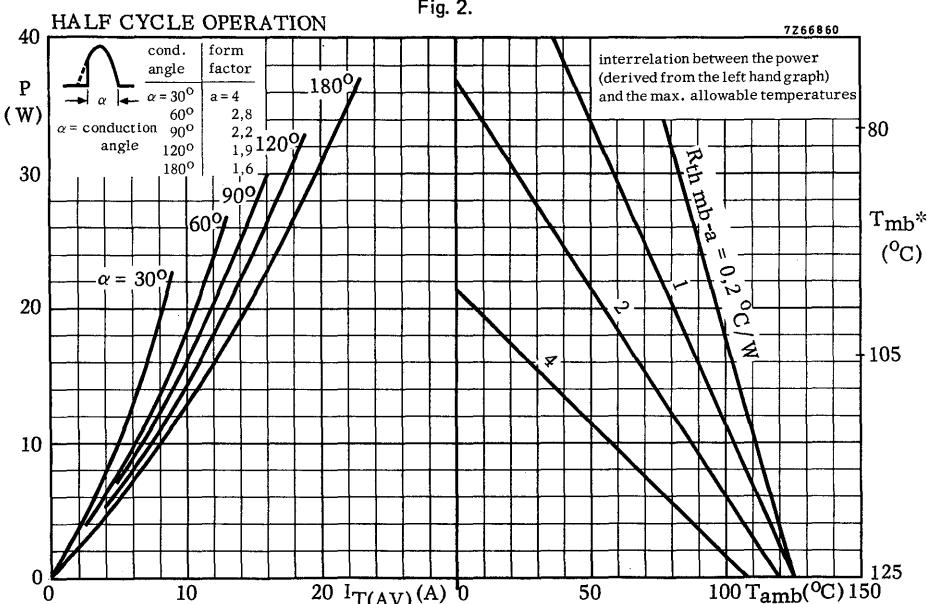


Fig. 3.

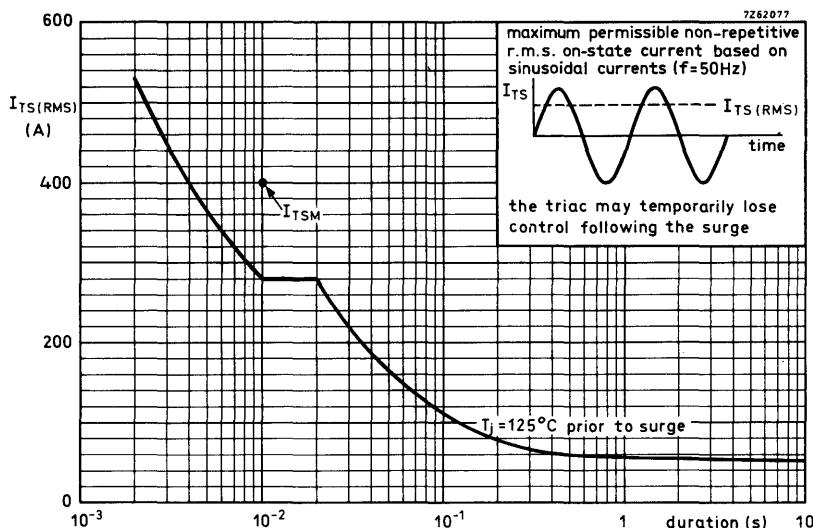


Fig. 4.

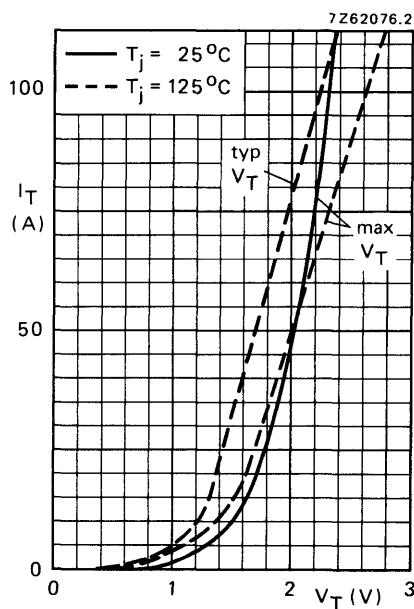


Fig. 5.

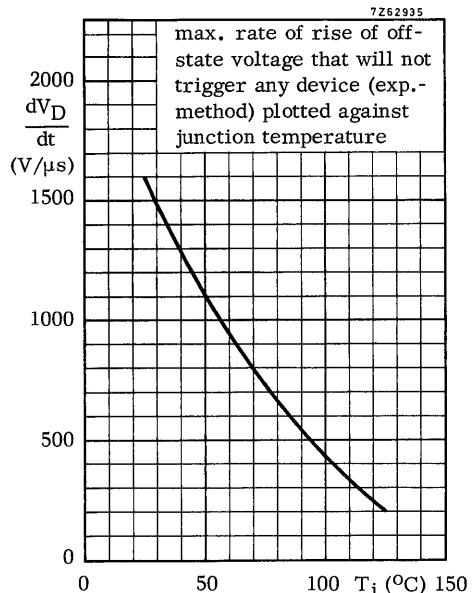


Fig. 6.

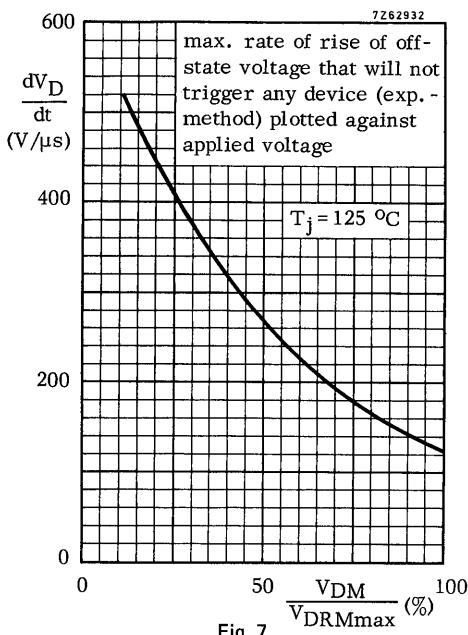


Fig. 7.

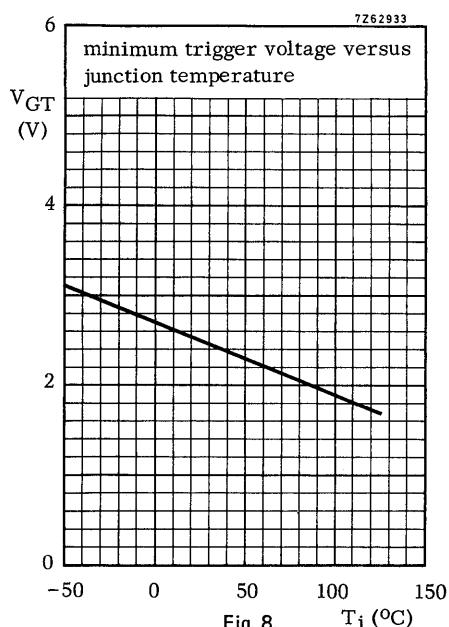


Fig. 8.

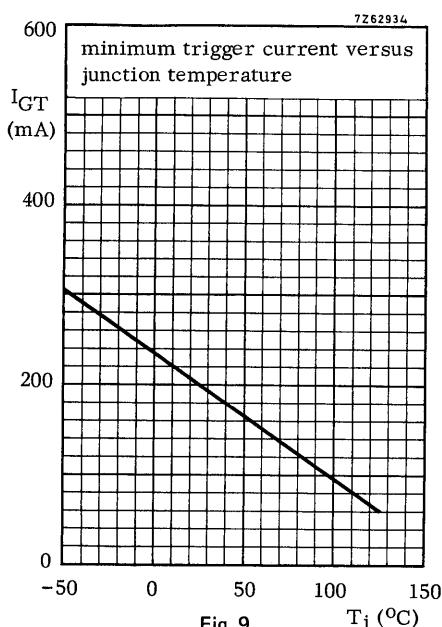


Fig. 9.

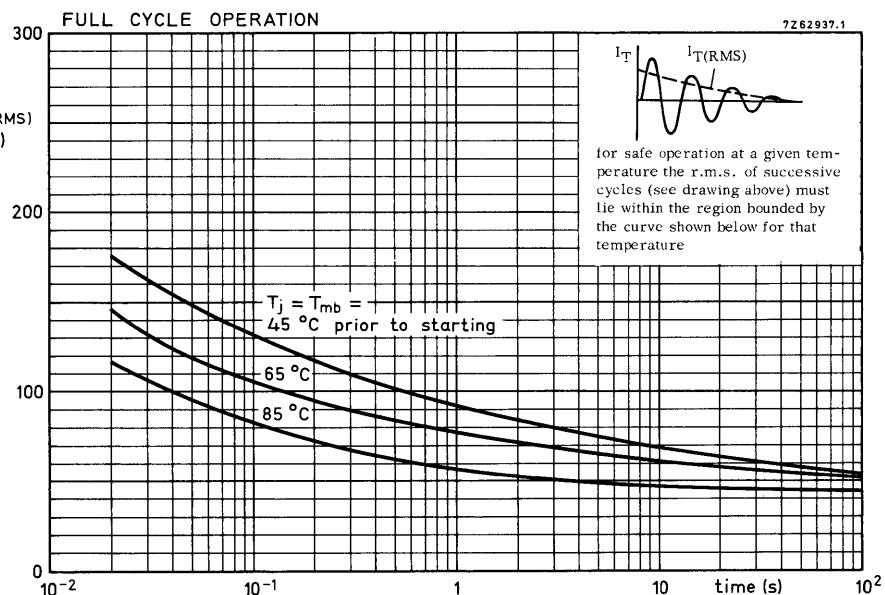


Fig. 10.

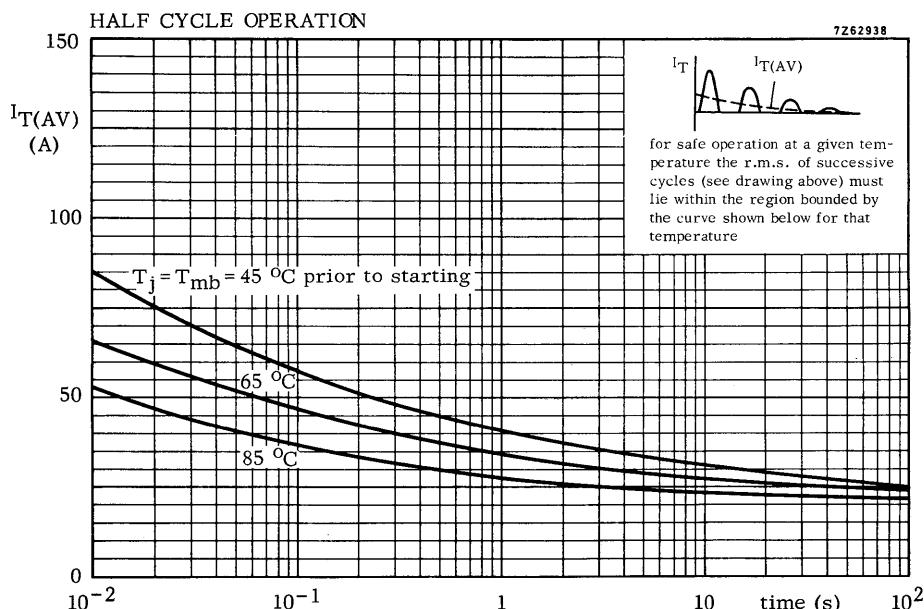


Fig. 11.

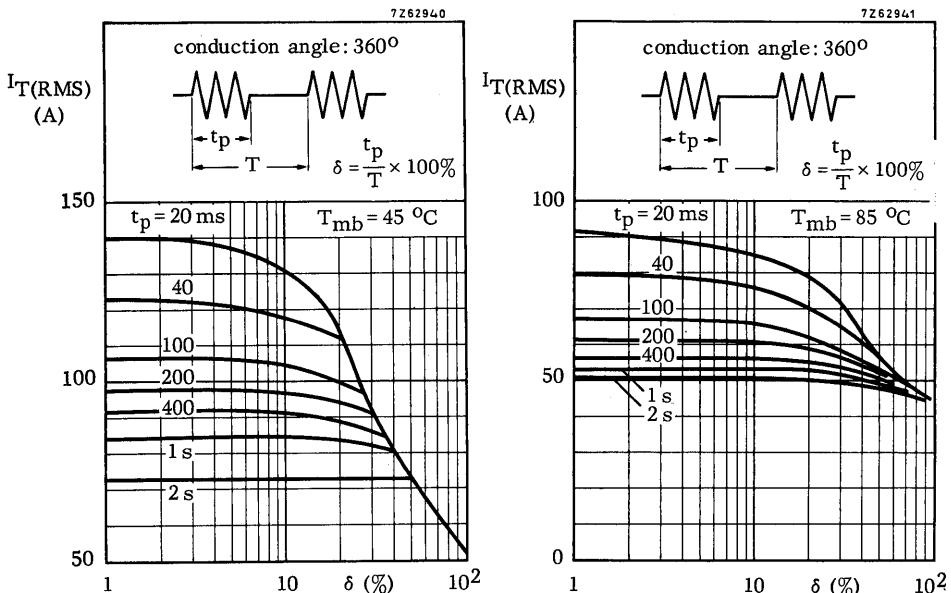


Fig. 12 Intermittent overload capability of one triac in a single phase a.c. control circuit.

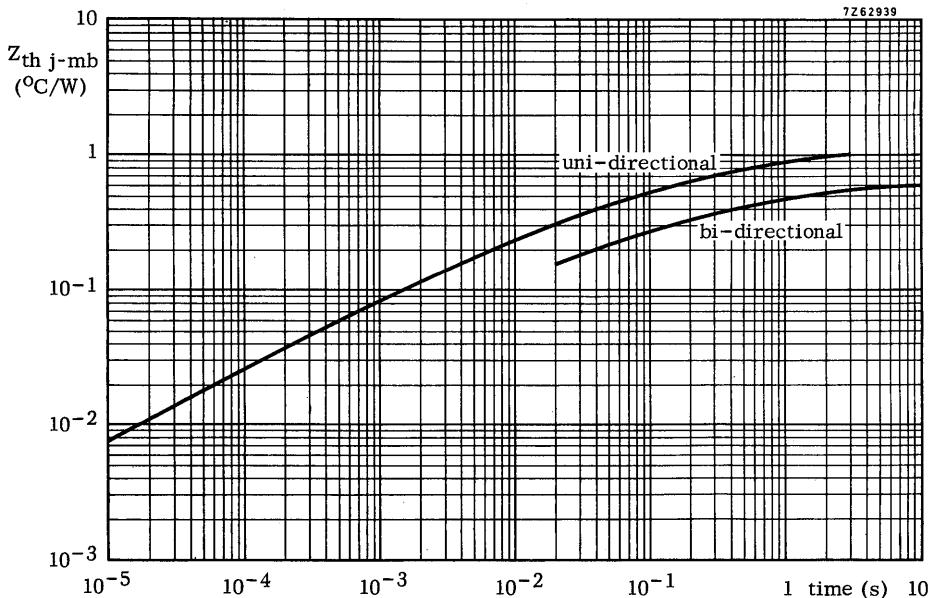


Fig. 13.